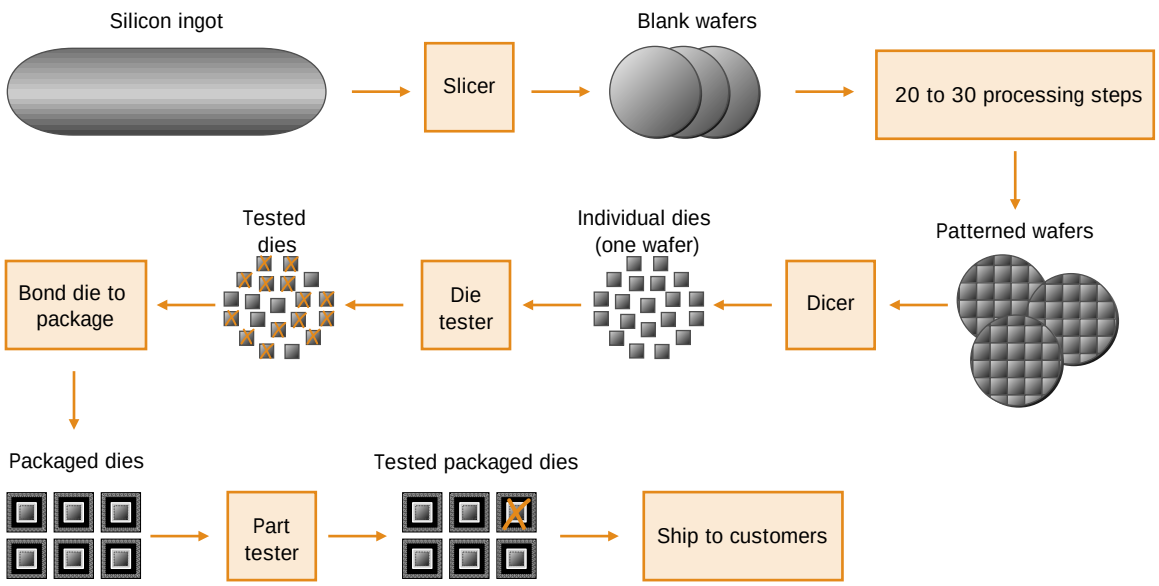
Silicon ingot
Slicer
Blank wafers
20 to 30 processing steps
Patterned wafers
Dicer
Individual dies
(one wafer)
Die
tester
Tested
dies
Bond die to
package
Packaged dies
Part
tester
Tested packaged dies
Ship to customers